

JUL 17 2003

**TRANSMITTAL LETTER**  
**(General - Patent Pending)**

Docket No.

IIZ.003D2

In Re Application Of:

Takashi Ohsumi

Serial No.  
09/920,713 /Filing Date  
August 3, 2001Examiner  
Fernando ToledGroup Art Unit  
2823

**Title: A METHOD FOR FABRICATING A SEMICONDUCTOR APPARATUS INCLUDING A SEALING MEMBER WITH REDUCED THERMAL STRESS (As Amended)**

**TO THE COMMISSIONER FOR PATENTS:**

Transmitted herewith is:

**Request for Reconsideration**

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in the above identified application.

- No additional fee is required.
- A check in the amount of \_\_\_\_\_ is attached.
- The Director is hereby authorized to charge and credit Deposit Account No. 50-0238 as described below.
  - Charge the amount of \_\_\_\_\_
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*Andrew J. Telesz, Jr.*  
*Signature*

Dated: July 17, 2003

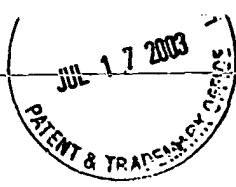
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I certify that this document and fee is being deposited on \_\_\_\_\_ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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CC:



Serial No. 09/920,713  
IIZ.003D2  
*Request for Reconsideration dated July 17, 2003*

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re PATENT APPLICATION of

Takashi Ohsumi

Group Art Unit: 2823

Serial No.: 09/920,713

Examiner: Fernando Toledo

Filed: August 3, 2001

FOR: A METHOD FOR FABRICATING A SEMICONDUCTOR APPARATUS  
INCLUDING A SEALING MEMBER WITH REDUCED THERMAL STRESS  
(As Amended)

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**REQUEST FOR RECONSIDERATION**

U.S. Patent and Trademark Office  
2011 South Clark Place  
Customer Window, **Mail Stop AF**  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, VA 22202

Date: July 17, 2003

Sir:

In response to the Final Office Action dated April 17, 2003, the following remarks  
are respectfully submitted in connection with the above identified application.

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